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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of:
Awad, et al.

Serial No.: 10/710,510

Filed: July 16, 2004

Group Art Unit: 2818

Examiner: Ho, Tu Tu V.

Atty. Docket No.: BUR920030175US1

Certificate of Mailing

I hereby certify that this correspondence is being deposited as First Class Mail with the United States Post Office and addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on June 21, 2005

Mohammad S. Rahman

For: DESIGN OF BEOL PATTERNS TO REDUCE THE STRESSES ON STRUCTURES BELOW CHIP BONDPADS

AMENDMENT UNDER 37 C.F.R. §1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Office Action mailed May 12, 2005, setting a three-month statutory period for response. Therefore, this amendment is timely filed. Please amend the above-identified patent application as follows: